

## 05U1 **THRU** 05U4

### SURFACE MOUNT GLASS PASSIVATED SUPER FAST SILICON RECTIFIER

VOLTAGE RANGE 50 to 200 Volts CURRENT 0.5 Ampere

### **FEATURES**

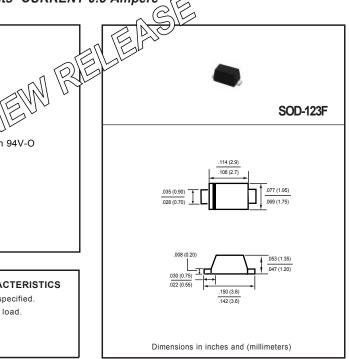
- \* Glass passivated device
- \* For surface mounted applications
- \* Ultrafast recovery times dor high efficiency
- \* Low forward voltage, low power loss
- \* Low leakage current

#### **MECHANICAL DATA**

- \* Epoxy: Device has UL flammability classification 94V-O
- \* Metallurgically bonded construction
- \* Mounting position: Any \* Weight: 0.016 gram



Ratings at 25  $^{\circ}\text{C}$  ambient temperature unless otherwise specified. Single phase, half wave, 60 Hz, resistive or inductive load. For capacitive load, derate current by 20%.



#### MAXIMUM RATINGS (@ TA=25 °C unless otherwise noted)

RATINGS	SYMBOL	05U1	05U2	05U3	05U4	UNITS
Maximum Recurrent Peak Reverse Voltage	V <sub>RRM</sub>	50	100	150	200	Volts
Maximum RMS Voltage	V <sub>RMS</sub>	35	70	105	140	Volts
Maximum DC Blocking Voltage	V <sub>DC</sub>	50	100	150	200	Volts
Maximum Average Forward Rectified Current at T <sub>A</sub> = 55°C	Io	0.5				
Peak Forward Surge Current 8.3 ms single half sine-wave superimposed on rated load (JEDEC method)	I <sub>FSM</sub>	15				
Typical Thermal Resistance (Note 1)	R <sub>θJA</sub>	θЈА 120				°C/W
Typical Thermal Resistance (Note 1)	Røjl	20				
Typical Junction Capacitance (Note 2)	CJ	18				
Operating Temperature Range	TJ	150				
Storage Temperature Range	T <sub>STG</sub>	-55 to + 150				

#### ELECTRICAL CHARACTERISTICS(@TA=25 °C unless otherwise noted)

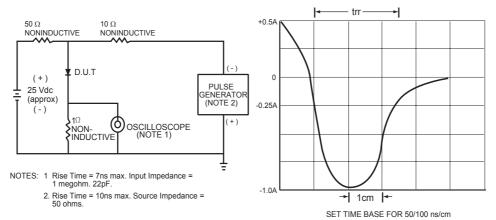
(@			,				
CHARACTERISTICS		SYMBOL	05U1	05U2	05U3	05U4	UNITS
Maximum Instantaneous Forward Voltag	V <sub>F</sub>	0.95				Volts	
Maximum Average Reverse Current	@T <sub>A</sub> = 25°C		5				
at Rated DC Blocking Voltage	@T <sub>A</sub> = 100°C	IR	350				
Maximum Reverse Recovery Time (Note 4)		trr	20				nSec

NOTES: 1. Thermal Resistance: Mounted on PCB.

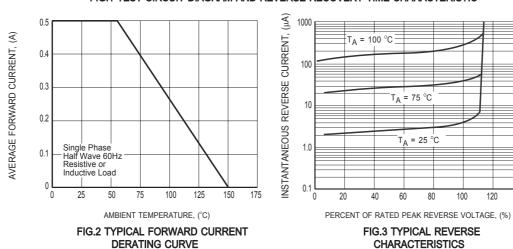
- 2. Measured at 1 MHz and applied reverse voltage of 4.0 volts.
- 3. "Fully ROHS compliant","100% Sn plating (Pb-free)".
  4. Test Conditions: I<sub>F</sub>= 0.5A, I<sub>R</sub>= -1.0A, I<sub>RR</sub>= -0.25A.

2006-12

### RATING AND CHARACTERISTICS CURVES (05U1 THRU 05U4)

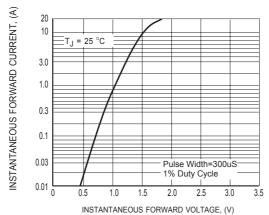


### FIG.1 TEST CIRCUIT DIAGRAM AND REVERSE RECOVERY TIME CHARACTERISTIC



140

### RATING AND CHARACTERISTICS CURVES (05U1 THRU 05U4)



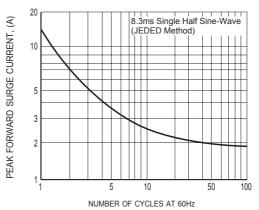
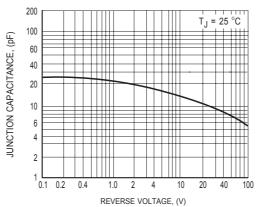
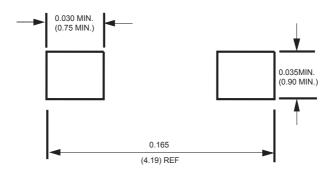


FIG.4 TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

FIG.5 MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT



# **Mounting Pad Layout**



Dimensions in inches and (millimeters)



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